

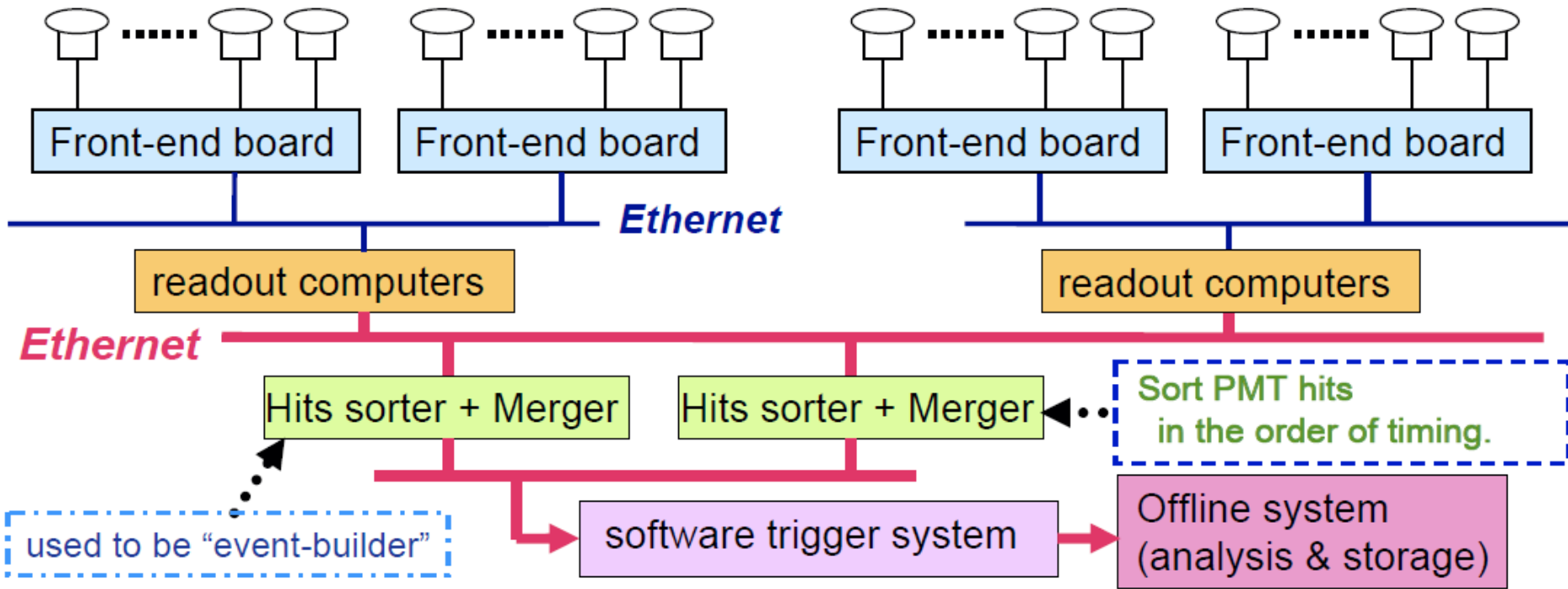
# Baseline design of electronics and DAQ system

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for the electronics /online working group

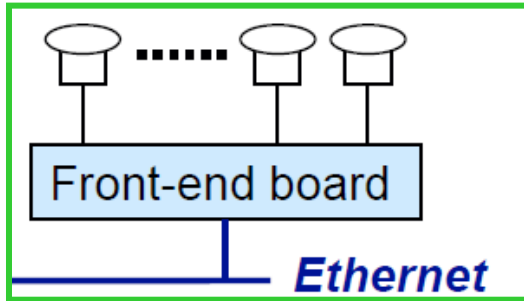
- 1) Design overview
- 2) Schematic diagram of the front-end module
- 3) Arrangements of the modules “in the detector”
- 4) Expected data rate from the online system  
~ effects of the dark rate ~

# Current schematic diagram of the HK DAQ system

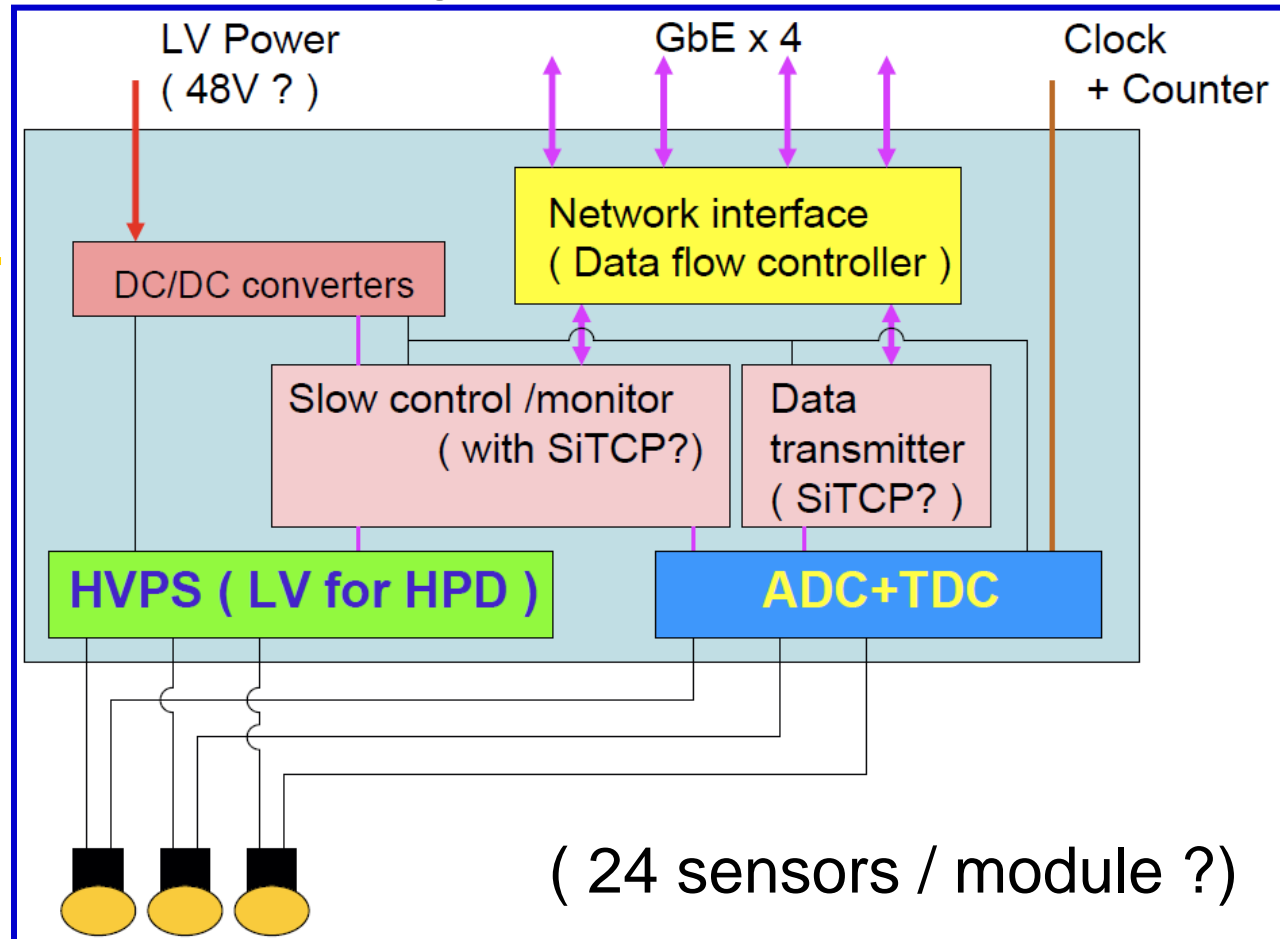


- 1) Signals from the photo sensor above discriminator threshold are continuously digitized.
- 2) All the “digitized” hit information including dark noise are sent to the readout computers.
- 3) Define events using the software trigger and send them to the offline system and also store the events in the disk.

# Possible front-end electronics module connections



## Schematic diagram of the front-end board



### Key components

- Self triggering & dead-time free ADC + TDC
- HV ( LV ) for photo-sensors
- Intelligent network interfaces

In the last meeting, experts strongly recommend

to keep the module DRY ( not to in the water ).

Detector design group want to reduce the weight of the cables....

# Possible front-end electronics module connections

~ Design of the data flow

1) Assuming to use 1GbE

- Robustness
- Power consumption

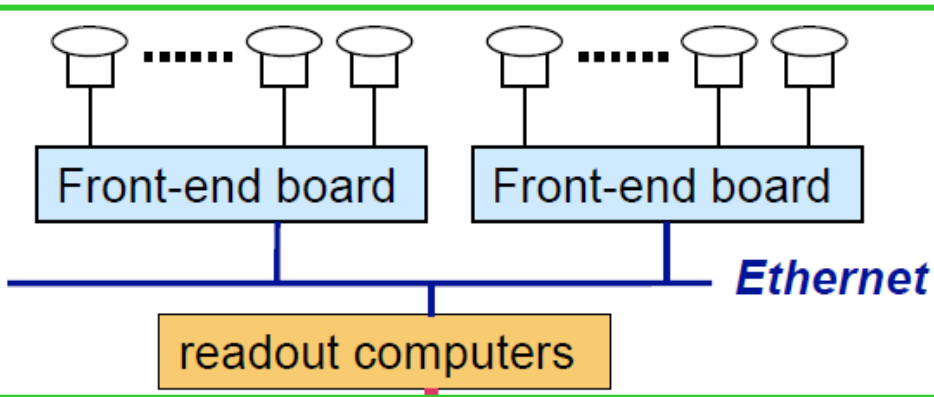
2) Connect neighboring Front-end boards each other

- Reduce total length of the cables
- Avoid single point failure

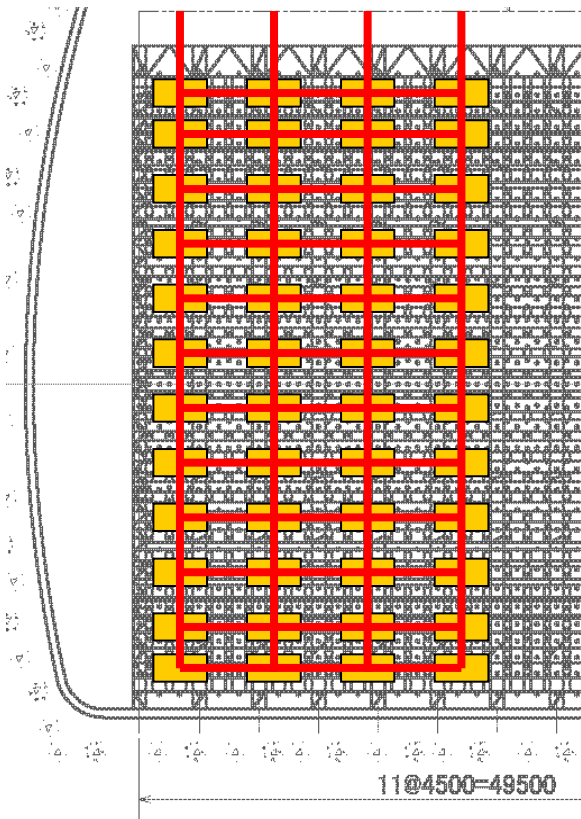
Usually, data collected by a module are transferred to the upper module (vertically)

If a module failed, transfer data to the other module instead of the failed module (horizontally).

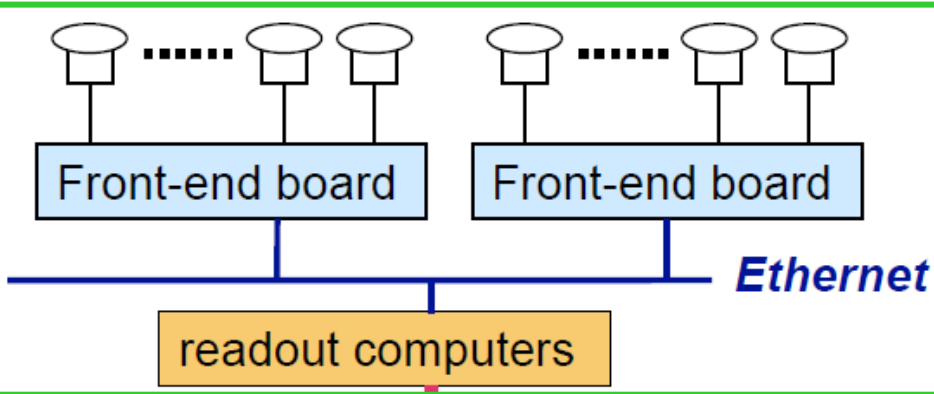
Data rate at the top modules has to be enough smaller than 1Gb/sec.



**HK detector Side view**

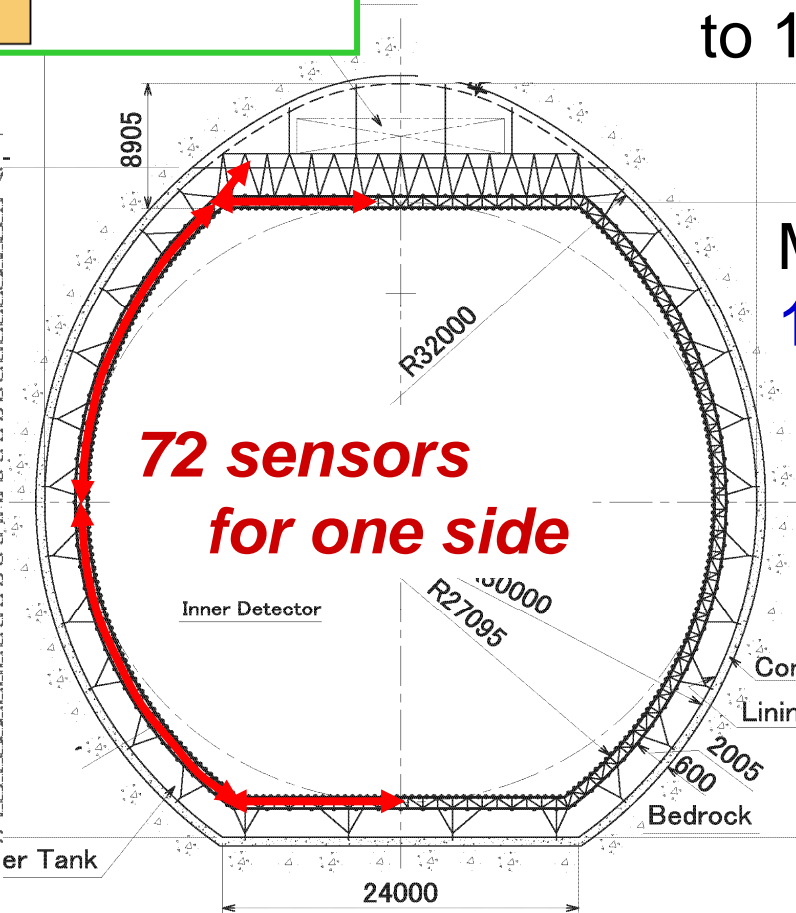
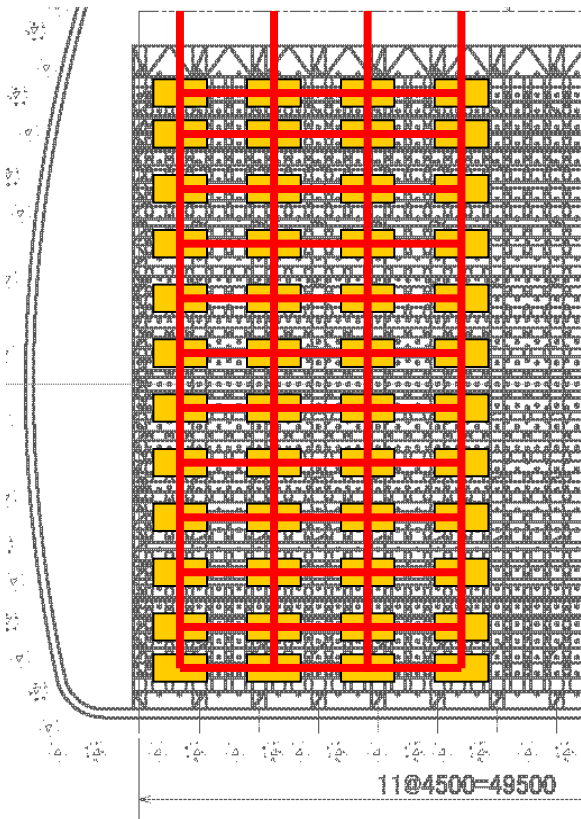


# Possible front-end electronics module connections



- From top to the bottom  
~ 72 sensors / side
- Connect 6 x 4 sensors  
( vertical x horizontal )  
to 1 front-end board

**HK detector Side view**



↓  
Maximum  
18 boards / cable

# Possible front-end electronics module connections

Data rate from one front-end board  $\sim 200 \times [\text{dark rate}] \text{ B/sec}$   
( assuming 24 ch / board )

Possible configuration

for 10 kHz dark rate

Dark rate

1) 5kHz

Data rate  $\sim 1 \text{ MB/sec/board}$   
Connect 18 boards / cable

1 cable from each side

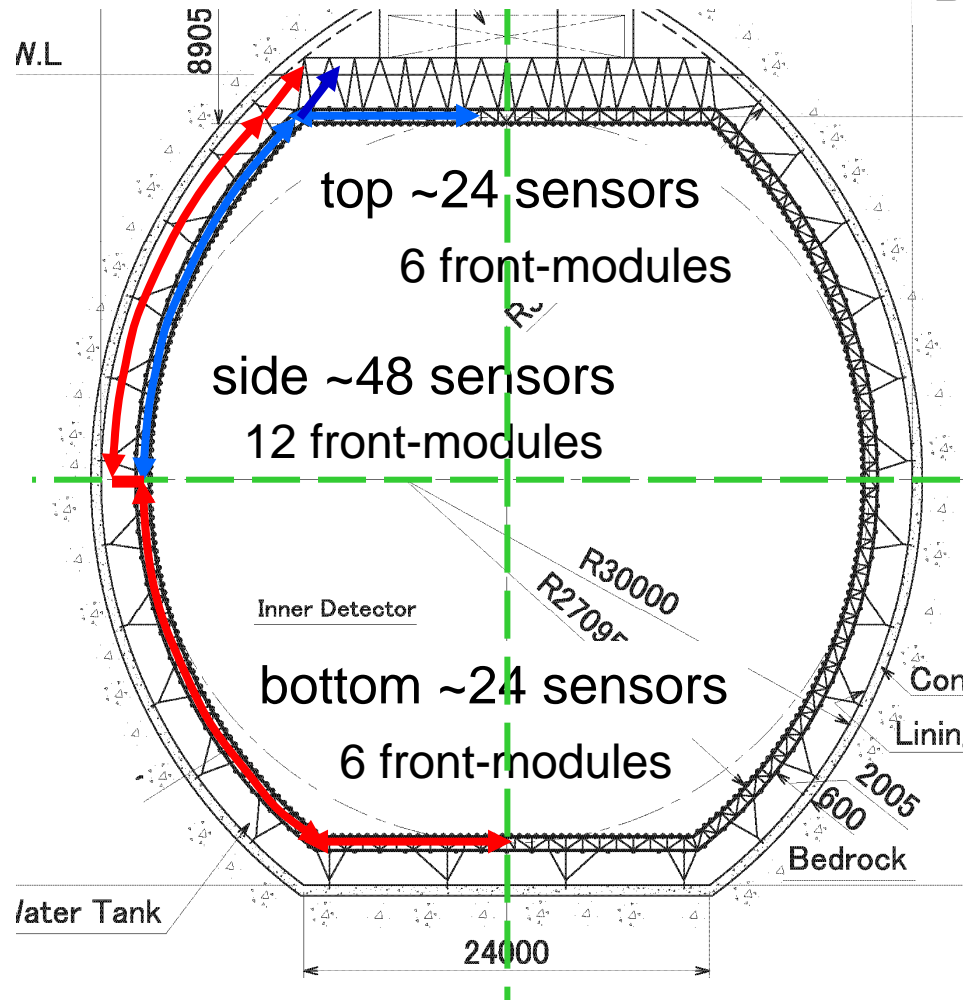
**In total  $\sim 120$  signal cables are coming out from single tank**

2) 10kHz

Data rate  $\sim 2 \text{ MB/sec/board}$   
Connect 9 boards / cable

2 cables from each side

**In total  $\sim 240$  signal cables are coming out from single tank**



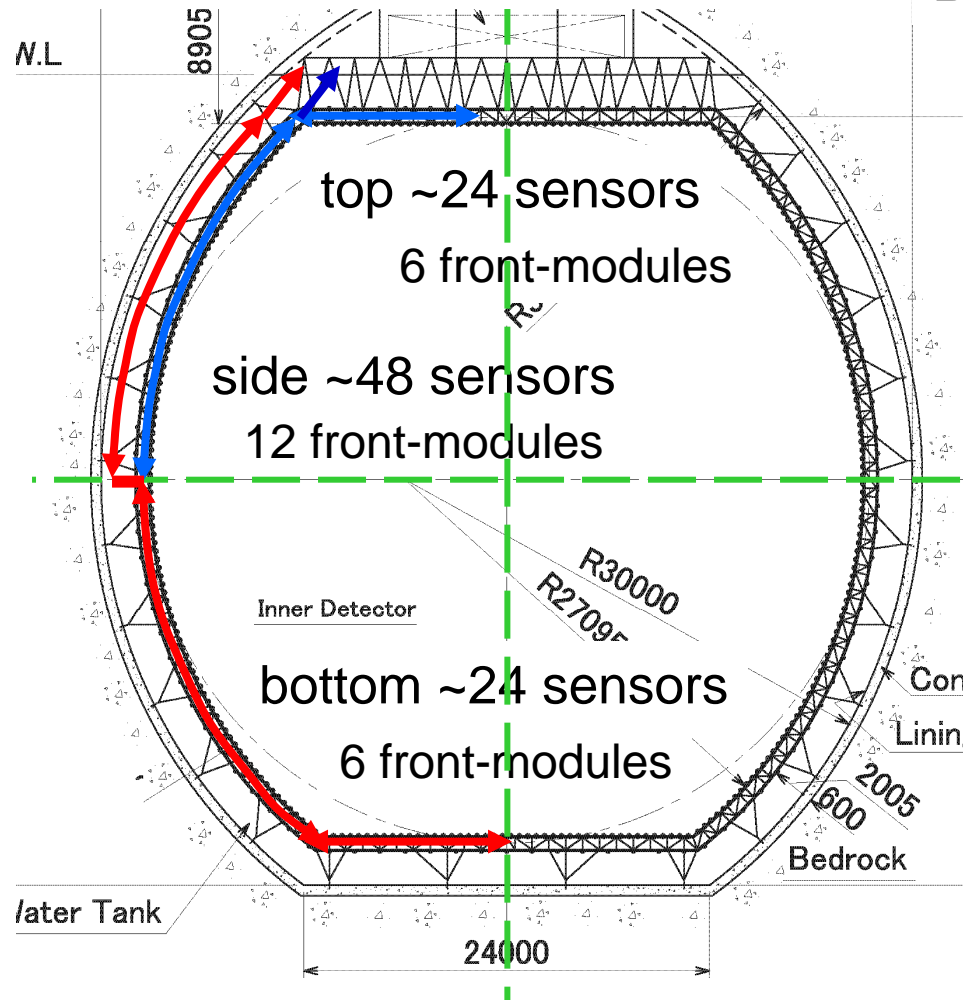
# Possible front-end electronics module connections

Data rate from one front-end board  $\sim 200 \times [\text{dark rate}] \text{ B/sec}$   
( assuming 24 ch / board )

Possible configuration

for 10 kHz dark rate

Dark rate



If dark rate is  $\sim 100\text{kHz}$   
data rate from a board  
 $\sim 20 \text{ MB/sec!}$

It might be possible to connect  
two modules  
and share one 1 GbE cable.

→  $\sim 1200$  signal cables

Also,  
total “raw” data rate  
**50GB/sec/tank!**

# # of channels per 1 front-end board

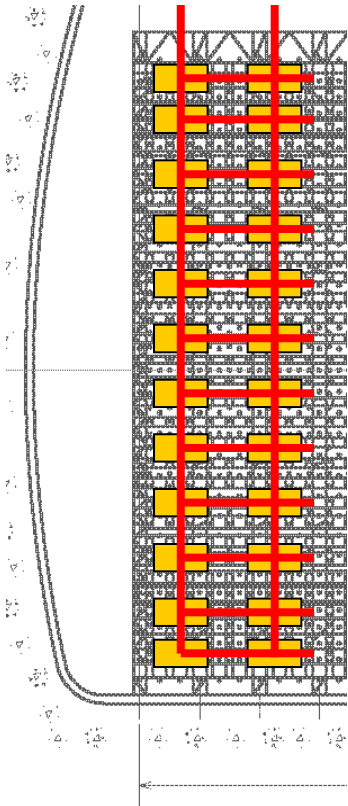
# of channels per board

Usually, high density module is favored in terms of cost.

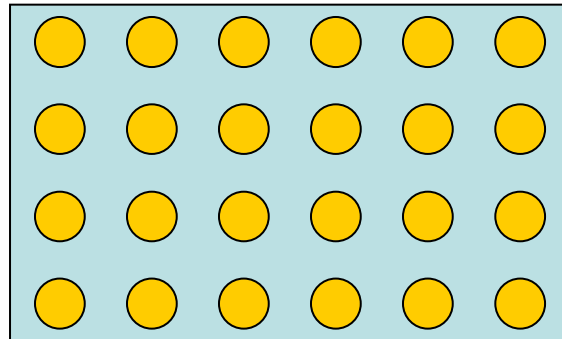
- Restrictions
- Data rate per module
  - Allowed size of the “dead region”

↙ Effects could be reduced with better arrangements?

**HK detector**  
**Side view**

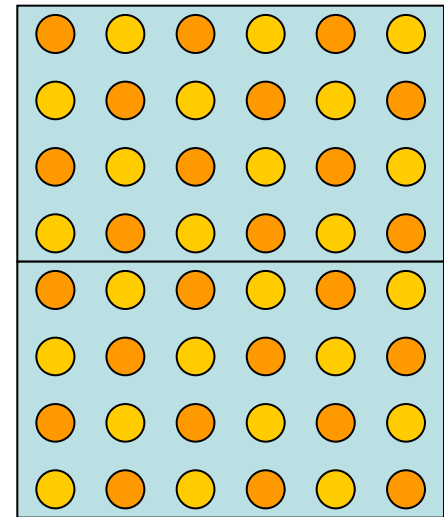


**Simple configuration**  
**( like SK )**



All sensors in a block are connected to one front-end board

**Possible alternative**



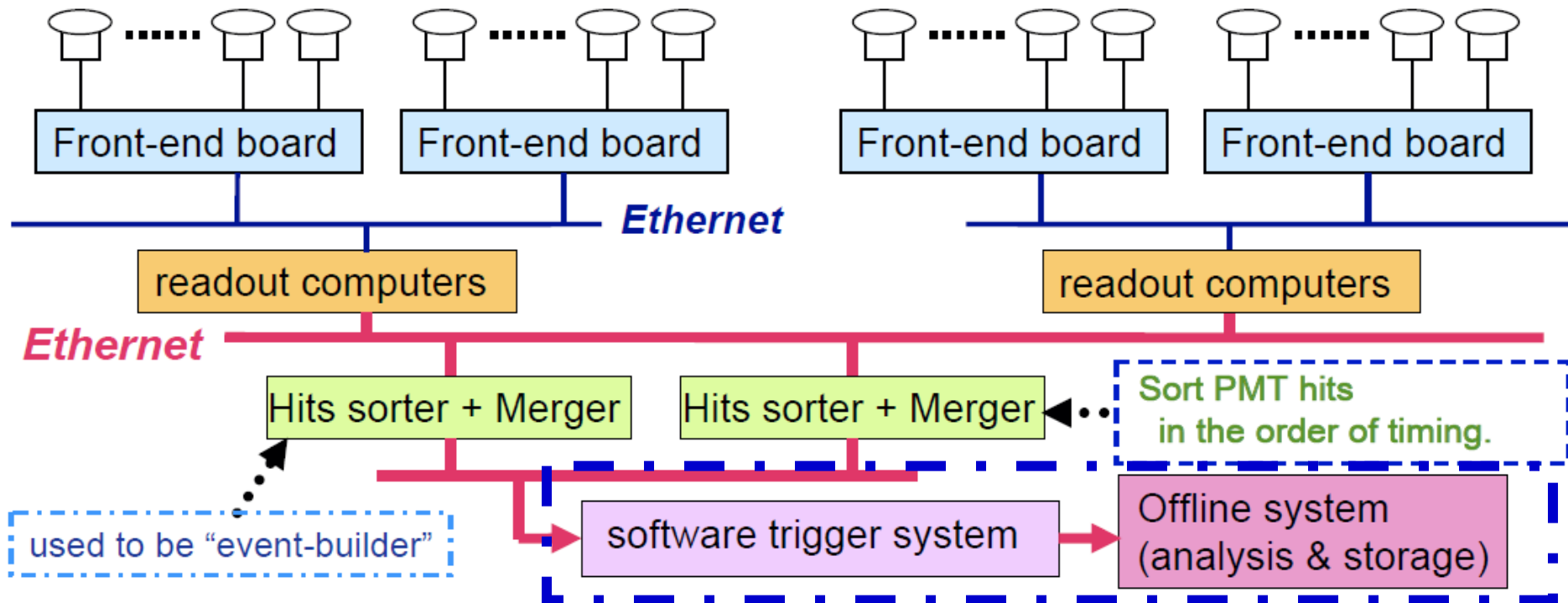
Connect neighboring sensors to different front-end boards





# Data rate after the software trigger

~ real-time data processing ~



## Trigger rates and data sizes of "real" events

- How many photo-sensors have hits from signal photons.
- How high the trigger rates for each trigger type will be
- How wide the gate width will be.
- How high the nominal dark hit rate will be.

( There might be "fake events" from dark hits. )

# Data rate after the software trigger

~ real-time data processing ~

## 1) Trigger rates and data sizes of “real” events

a) How many photo-sensors have hits from signal photons.

assuming **20% photo-coverage** and

**20 ~ 30% quantum efficiency**

***3 ~ 4.5 hits / MeV ( based on SK experiences )***

b) How high the trigger rates for each trigger type will be

c) How wide the gate width will be

Need assumption ( here, **N** is the # of compartments )

Trig. type	Trig. rate	Gate	Signal hits
SLE	3,000 Hz	1.3 us	25
LE	35 Hz	40 us	50
Muon	<b>30 ~ 150 Hz</b>	40 us	50000 / N
Calibration	1 Hz	40 us	50000 / N
pedestal	2 Hz	17 us	50000 / N * 3

# Data rate after the software trigger

~ real-time data processing ~

1) Trigger rates and data sizes of “real” events

d) How high the nominal dark hit rate will be.

Assume ~ 10kHz

( nominal dark rate for SK-PMT = 3 ~ 5 kHz )

Expected data rates after the software trigger

case 1) 3 compartments (  $N = 3$  )

10 kHz dark, 17 k sensors / compartment

$\mu$  rate = **35 Hz** ( muon rate \* area ~ 18 times larger )

~ 15 MB/sec/compartment

**~ 40 % from SLE & 40% from  $\mu$**

case 2) single compartment

10 kHz dark, 50 k sensors / compartment

$\mu$  rate = **150 Hz** ( muon rate \* area ~ 60 times larger )

~ 110 MB/sec

**~ 80 % from  $\mu$**

**( not all the SLE events &  $\mu$  are necessary to be stored in the disk )**

# Fake event rate ~ dark rate and majority trigger

Primarily, simple “majority” trigger is assumed.

Count # of hit photo-sensors

within a few ~ several hundreds of ns

If # of hits exceeds the threshold,

hit data are recorded as an event.

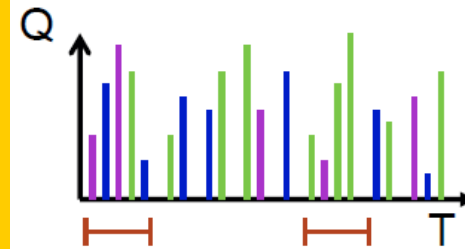
Collect all the hits in a detector ( compartment )

and search for the timing cluster ( peak )

1) sort hits in order of time

2) search for events

by software or hardware



- Need to extend the “trigger gate width”  
as the detector gets larger.
- Accidental # of hits increases if dark rate gets higher  
and “trigger gate width” gets wider.

Dark hits may issue trigger ~ fake events.

# Fake event rate ~ dark rate and majority trigger

How wide the coincidence gate should be?

~ how far a photons is expected to travel?

Size of the detector ~ **45 m  $\phi$  x 50 m L**  
max. photon travel time ~ **200 ns**

Size of the detector ~ **45m  $\phi$  x 250m L**  
max. photon travel time < **1000 ns**

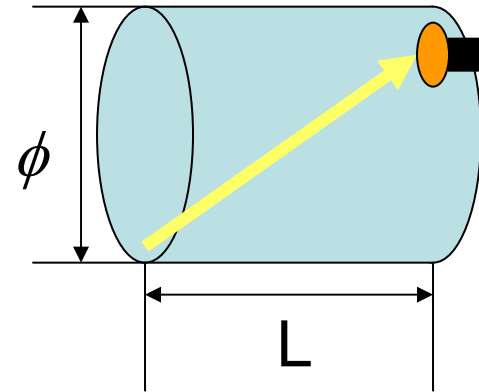
Considering the absorption / scattering length  
( 80 ~ 100m )

~ **500ns is ( expected to be ) sufficient**

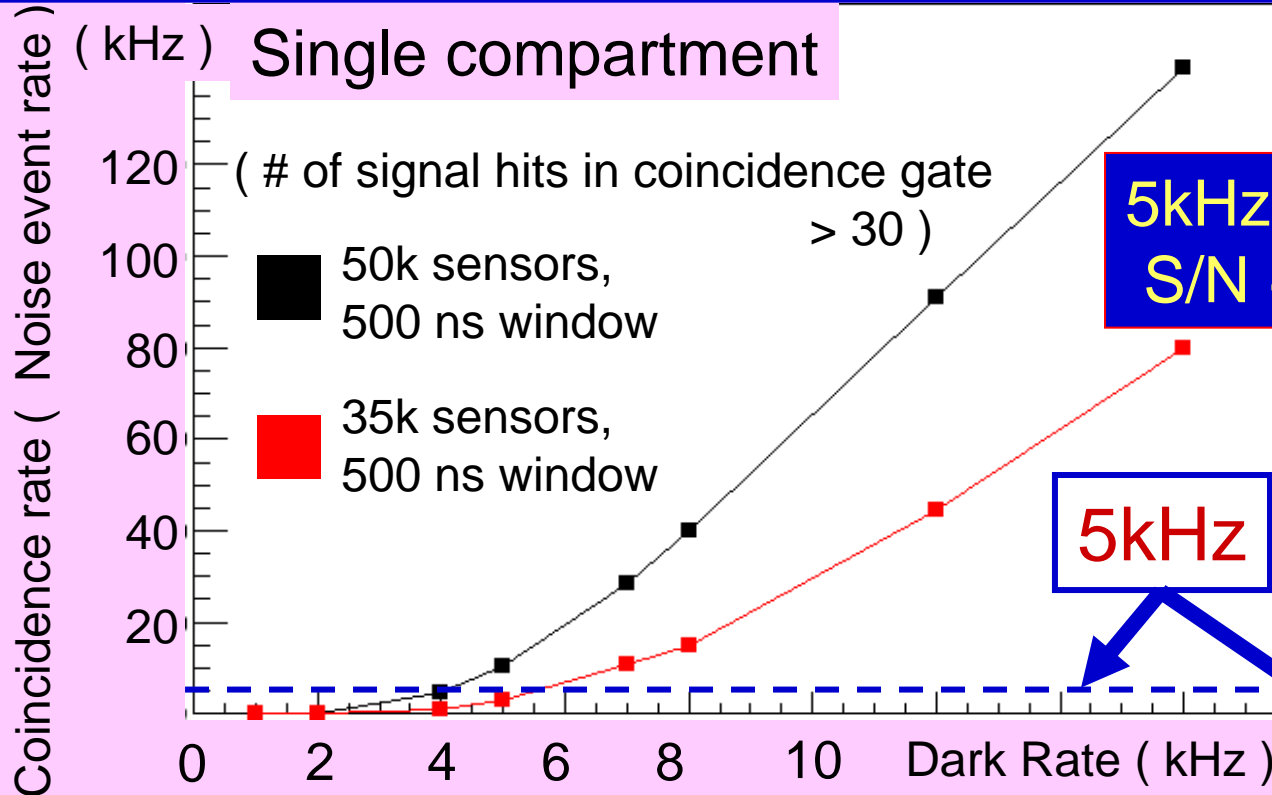
Evaluation of the fake trigger rate ( noise event rate )

For 5 compartment case ( default configuration ),  
assume coincidence gate to be 200 ns.

Single compartment case,  
assume coincidence gate to be 500 ns.



# Fake event rate ~ dark rate and majority trigger

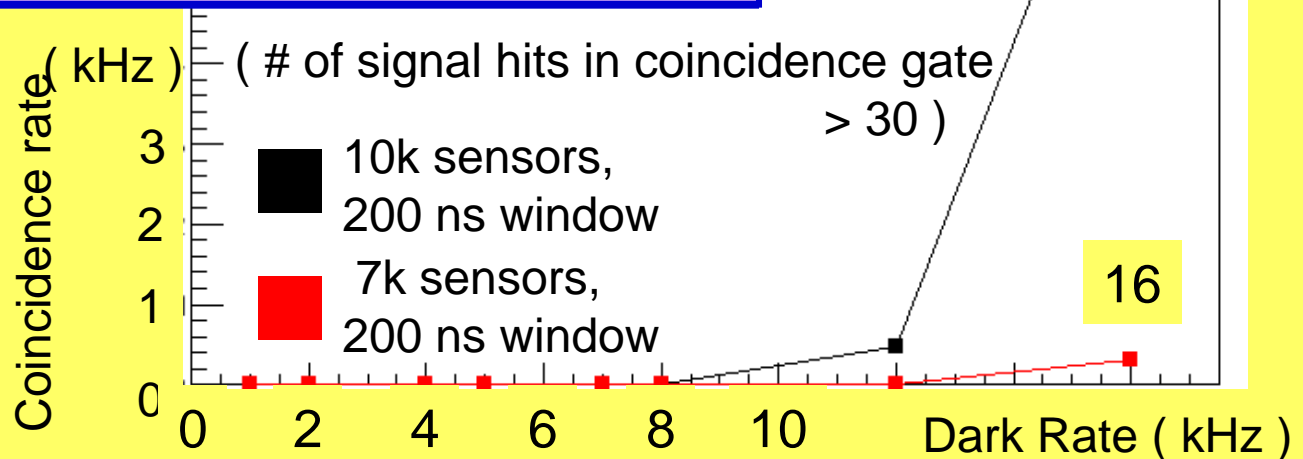


5kHz is not a solid value  
S/N ~ 1/1 or much worse

5kHz

5 compartments

S.Hirota  
( Photo sensor group )



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# Fake event rate ~ dark rate and majority trigger

1) Baseline configuration ( 5 compartments )

No problem for dark rate ~ **10 kHz or less.**

2) Another configuration ( single compartment )

Must be less than **a few kHz**

to use “simple” majority trigger.

Single compartment configuration

Careful design and configuration

with new ideas / implementation.

a) Cabling ( # of cables ) and efficient connections

b) Triggering scheme

c) Handling of the data

both in the online and the offline system.

Also in the analyses.

# Extremely rough estimate of the costs

## Electronics part

ADC/TDC ~ 480k / board ( 20k \* 24 channels )

Network ~ 50k / board

Control block ~ 50k / board

## LV/HV

power supply ~ 240k / board ( 10k \* 24 channels )

Connectors ~ 120k / board ( 5k \* 24 channels )

Case ~ 100k / board

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Total ~1040k / board

( for 100k channels, ~  $4.3 \times 10^9$  )



# Summary ~ R&D starting from this year

Actual design of the analog signal handling part  
and LV/HV components  
Need to wait for the final decision of the photo-sensor

Start R&D work of the following items:

- 1) Water-tight case for the electronics modules
- 2) Connectors and cables  
Water-tight connectors  
under-water network cable etc.
- 3) TDC ~ search for the candidate chips
- 4) Data handling components ( incl. network interface )

fin.

# Data rate from front-end electronics modules

Nominal hit data ( data rates ) are dominated by dark noise

1 hit corresponds to 64 bits

Cable ID ( with additional info )	32 bits
Timing	16 bits
Charge ( Q )	16 bits

Could be compressed to 48 bits but

“64 bits” block is faster to handle in the software.

Nominal data rate per channel

Dark noise rate :  $R_D$  kHz

$$\begin{aligned}\text{Data rate} &= R_D \times 1000 \times 8 \text{ bytes} \\ &= 8 \times R_D \text{ kB/sec/channel}\end{aligned}$$

Assuming  $R_D = 5\text{kHz}$

~ 40 kB/sec/channel

# Data rate from front-end electronics modules

Assuming  $R_D = 5\text{kHz} \sim 40 \text{ kB/sec/channel}$

24 ch / board  $\rightarrow \sim 1\text{MB/sec/board}$   
( current SK )

Assuming to use Gigabit Ethernet

( Limitation of the length of the cable and stability )

Want to limit nominal data rate  $< 30 \sim 50\text{MB/sec}$

(  $1/2 \sim 1/3$  compared to the maximum band width )

In order to reduce the # of cables from the tank,  
data from multiple modules are transferred  
via single GbE cable.

$\rightarrow$  *30 ~ 40 modules per cable* is one guide upper limit